

Product Summary (Typ. @ $V_{GS} = 4.5V$, $T_A = +25^{\circ}C$)

V_{DSS}	$R_{DS(ON)}$	Q_g	Q_{gd}	I_D
8V	35m Ω	9.6nC	0.9nC	4.0A

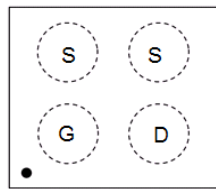
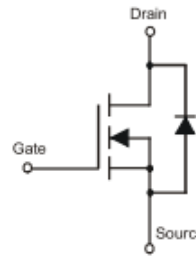
Description

The DMN1054UCB4 is a Trench MOSFET, engineered to minimize on-state losses and switch ultra-fast, making it ideal for high-efficiency power transfer. Using Chip-Scale Package (CSP) to increase power density by combining low thermal impedance with minimal $R_{DS(ON)}$ per footprint area.

Applications

- DC-DC Converters
- Battery Management
- Load Switch

X1-WLB0808-4


 Top-View
Pin Configuration


Equivalent Circuit

Features

- Trench-CSP Technology with the Lowest on Resistance:
 - $R_{DS(ON)} = 35m\Omega$ to Minimize On-State Losses
 - $Q_g = 9.6nC$ for Ultra-Fast Switching
- $V_{GS(TH)} = 0.6V$ Typ. for a Low Turn-On Potential
- CSP with Footprint 0.8mm x 0.8mm
- Height = 0.375mm for Low Profile
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

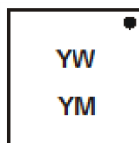
Mechanical Data

- Case: X1-WLB0808-4
- Terminal Connections: See Diagram Below

Ordering Information (Note 4)

Part Number	Case	Packaging
DMN1054UCB4-7	X1-WLB0808-4	3000/Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information


YW = Product Type Marking Code
 YM = Date Code Marking
 Y or \bar{Y} = Year (ex: D = 2016)
 M or \bar{M} = Month (ex: 9 = September)

Date Code Key

Year	2012	2013	2014	2015	2016	2017	2018
Code	Z	A	B	C	D	E	F

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	8	V
Gate-Source Voltage	V _{GSS}	±5	V
Continuous Source Current @ V _{GS} = 4.5V (Note 5)	I _D	T _A = +25°C 2.7	A
		T _A = +70°C 2.2	
Continuous Source Current @ V _{GS} = 4.5V (Note 6)	I _D	T _A = +25°C 4.0	A
		T _A = +70°C 3.2	
Pulsed Drain Current (Pulse duration 10μs, duty cycle ≤1%)	I _{DM}	8	A
Continuous Source-Drain Diode Current	I _S	0.74	A
Pulse Diode Forward Current	I _{SM}	15	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	P _D	0.74	W
Thermal Resistance, Junction to Ambient (Note 5)	R _{θJA}	169	°C/W
Total Power Dissipation (Note 6)	P _D	1.34	W
Thermal Resistance, Junction to Ambient (Note 6)	R _{θJA}	93	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	8	-	-	V	V _{GS} = 0V, I _D = 250μA
Zero Gate Voltage Drain Current	I _{DSS}	-	-	1.0	μA	V _{DS} = 8V, V _{GS} = 0V
Gate-Body Leakage	I _{GSS}	-	-	±100	nA	V _{GS} = ±5V, V _{DS} = 0V
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	0.35	-	0.7	V	V _{DS} = V _{GS} , I _D = 250μA
Static Drain-Source On-Resistance	R _{DS(ON)}	-	35 38.5 46.4 53.3 64.7	42 50 65 80 110	mΩ	V _{GS} = 4.5V, I _D = 1.0A V _{GS} = 2.5V, I _D = 1.0A V _{GS} = 1.8V, I _D = 0.5A V _{GS} = 1.5V, I _D = 0.2A V _{GS} = 1.2V, I _D = 0.1A
Forward Transfer Admittance	Y _{fs}	-	6.0	-	S	V _{DS} = 6V, I _S = 1.0A
Body Diode Forward Voltage	V _{SD}	-	0.7	1	V	V _{GS} = 0V, I _S = 1.0A
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C _{ISS}	-	698	908	pF	V _{DS} = 6V, V _{GS} = 0V, f = 1.0MHz
Output Capacitance	C _{OSS}	-	97	127	pF	
Reverse Transfer Capacitance	C _{ISS}	-	90	126	pF	
Gate Resistance	R _g	-	1.3	2.6	Ω	V _{DS} = 0V, V _{GS} = 0V, f = 1MHz
Total Gate Charge	Q _g	-	9.6	15	nC	V _{GS} = 4.5V, V _{DS} = 6V, I _D = 1.0A
Gate-Source Charge	Q _{gs}	-	0.9	-	nC	
Gate-Drain Charge	Q _{gd}	-	0.9	-	nC	
Turn-On Delay Time	t _{D(ON)}	-	5.2	10	ns	V _{DD} = 6V, I _D = 1.0A V _{GEN} = 4.5V, R _G = 1Ω, R _L = 6Ω
Turn-On Rise Time	t _r	-	6.7	14	ns	
Turn-Off Delay Time	t _{D(OFF)}	-	16.6	32	ns	
Turn-Off Fall Time	t _f	-	2	4	ns	
Reverse Recovery Charge	Q _{RR}	-	0.7	1.5	nC	I _F = 1A, di/dt = 100A/μs
Body Diode Reverse Recovery Time	t _{RR}	-	6.9	14	ns	

- Notes:
- Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 - Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate.
 - Short duration pulse test used to minimize self-heating effect.
 - Guaranteed by design. Not subject to production testing.

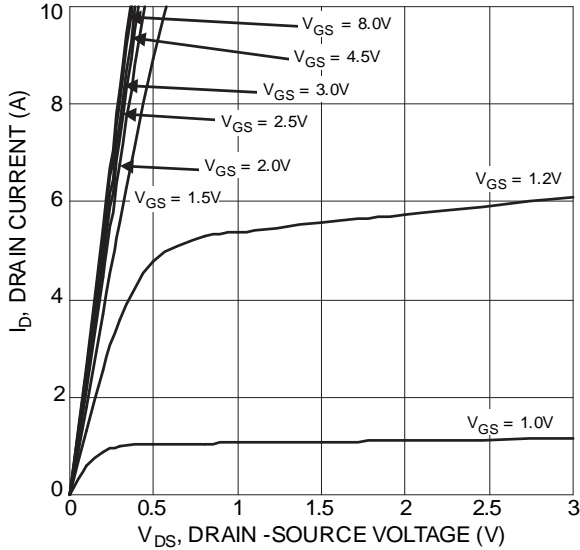


Figure 1 Typical Output Characteristics

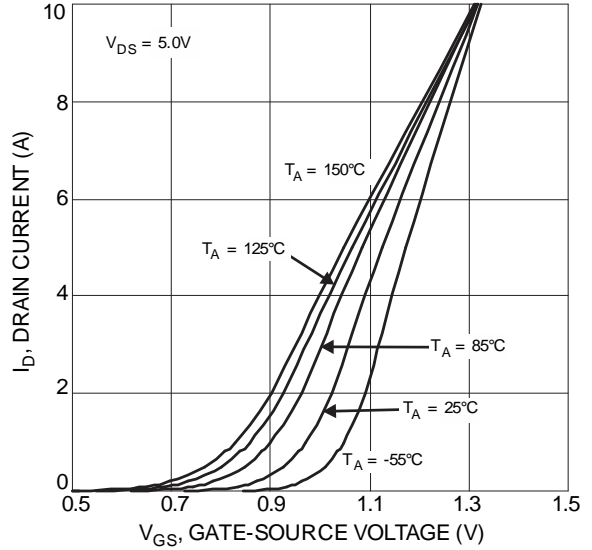


Figure 2 Typical Transfer Characteristics

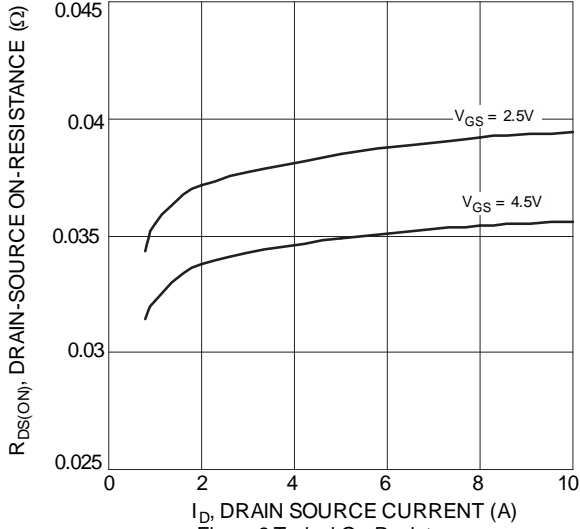


Figure 3 Typical On-Resistance vs. Drain Current and Gate Voltage

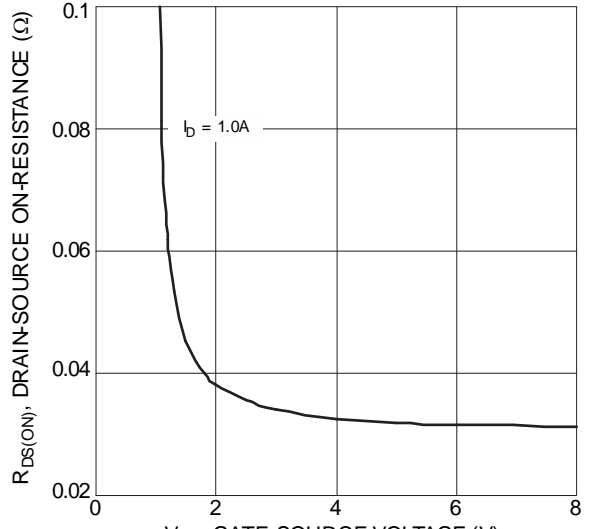


Figure 4 Typical Transfer Characteristic

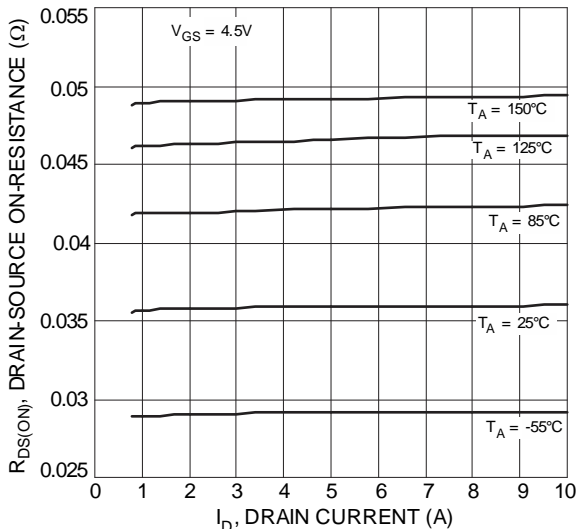


Figure 5 Typical On-Resistance vs. Drain Current and Temperature

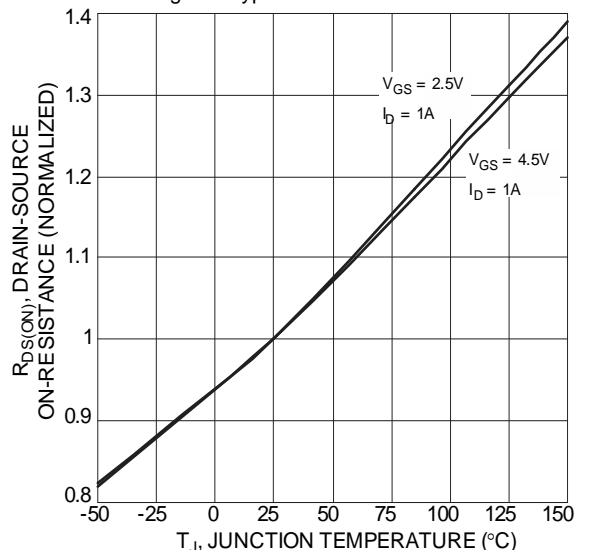
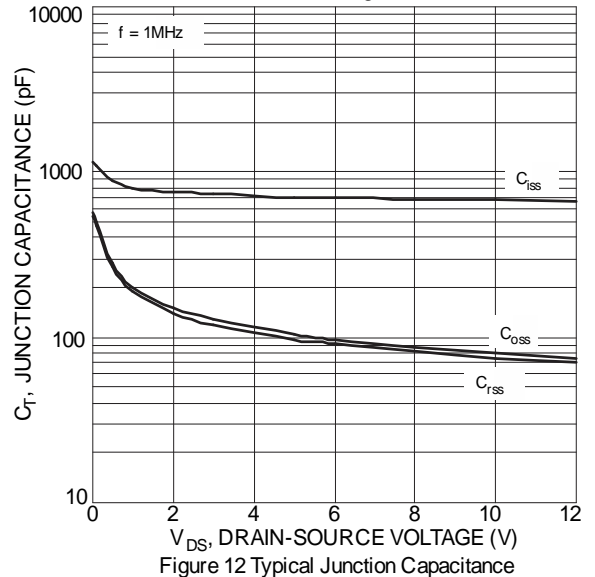
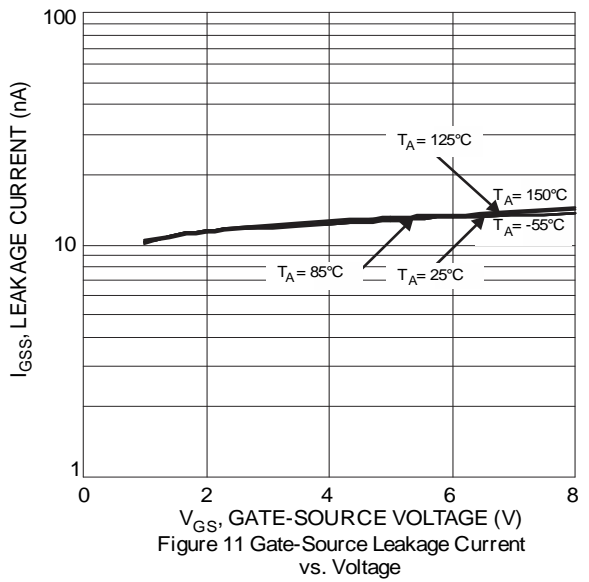
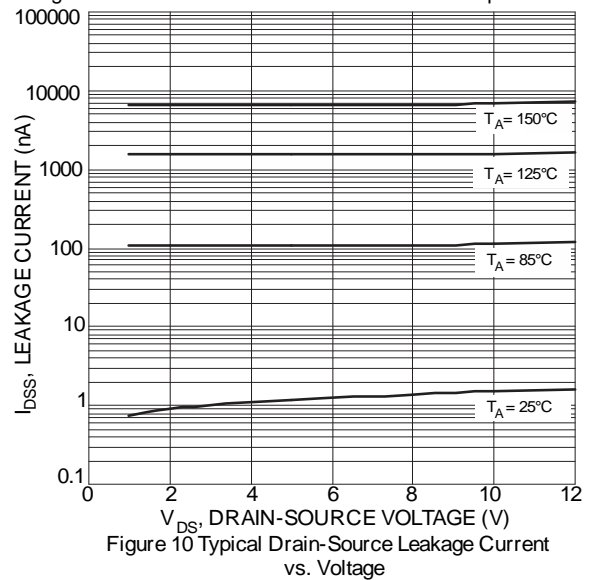
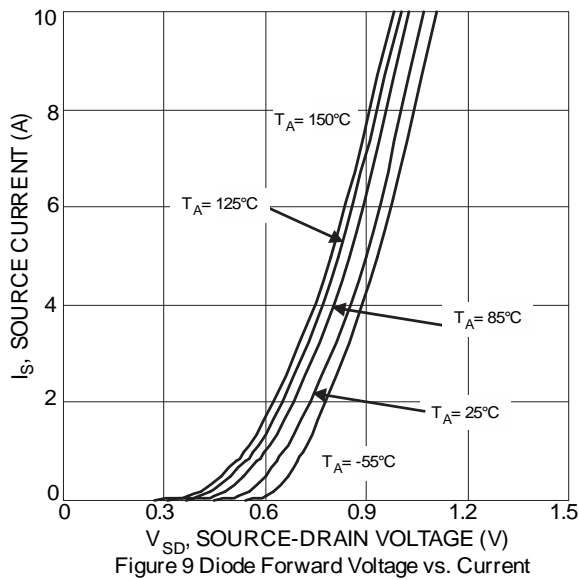
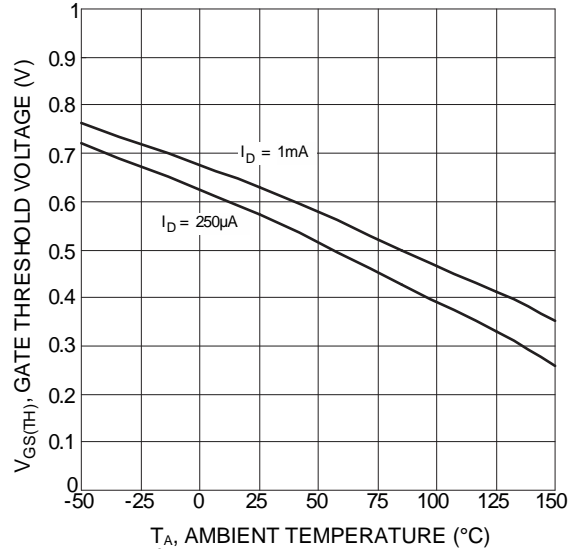
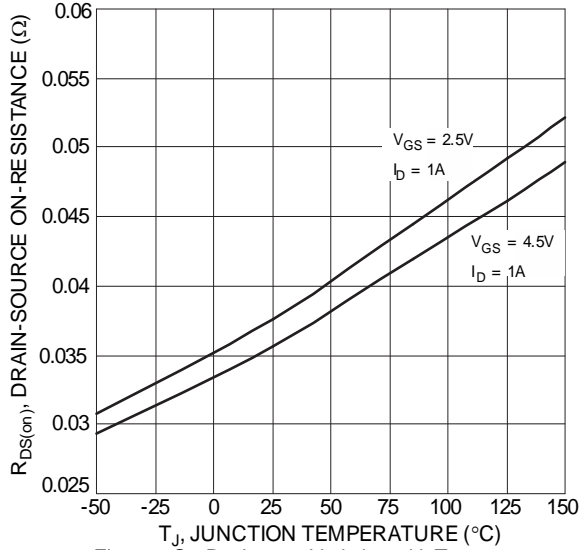
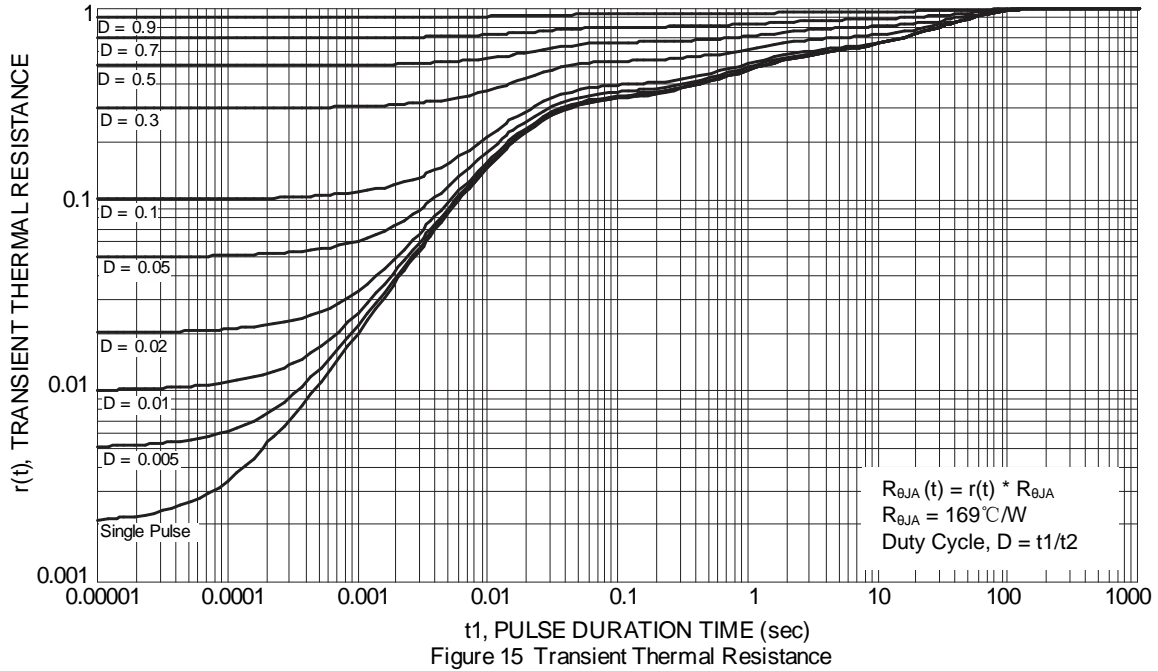
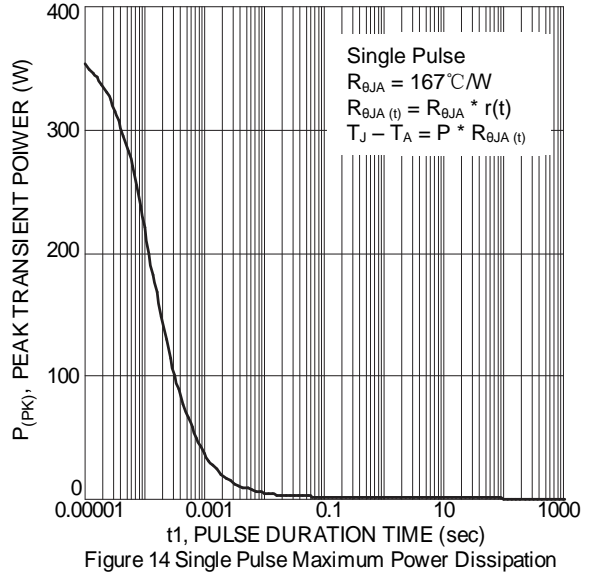
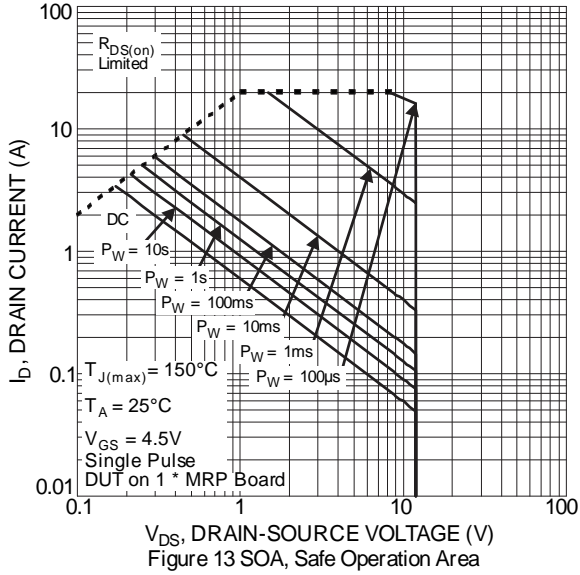


Figure 6 On-Resistance Variation with Temperature

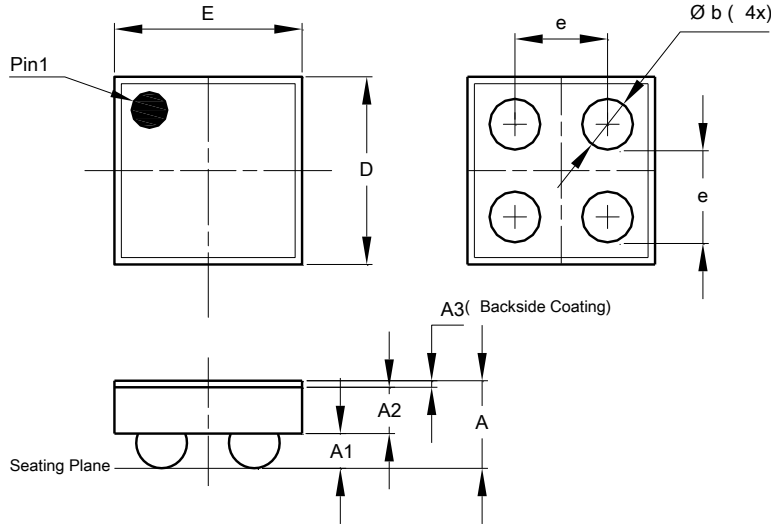




Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

X1-WLB0808-4

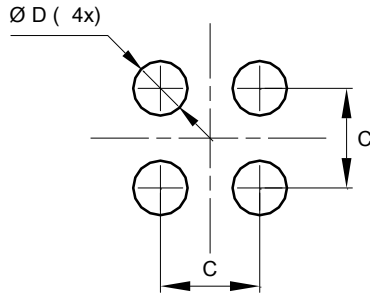


X1-WLB0808-4			
Dim	Min	Max	Typ
A	0.3320	0.4180	0.3750
A1	0.1350	0.1650	0.1500
A2	0.1750	0.2250	0.2000
A3	0.0220	0.0280	0.0250
b	0.1971	0.2409	0.2190
D	0.7900	0.8100	0.8000
E	0.7900	0.8100	0.8000
e	0.400 BSC		
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

X1-WLB0808-4



Dimensions	Value (in mm)
C	0.4000
D	0.2190

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